ΞÞ \triangleright ₽ \triangleright PART Z CORRECTION PART NAME TRIGON-APPD Q'TY CHKD MATERIAL SCALE DSCD ഗ STANDARD MODEL SMD SWITCHES INT-1410F25B DISPOSITION REMARKS

KNOB SIZE(L) : 2.5mm

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- - REEL IS 3,000PCS

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5. RESISTANCE : $100m\Omega$ MAX 4. RATING : 12V DC 50mA

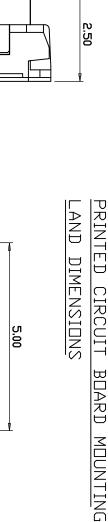
MANUFACTURING SPECIFICATION WOULD

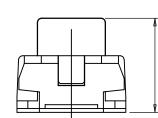
BE ACCORDANCE WITH MT0186

CIRCUIT DIAGRAM

1. DPERATING FORCE : 250gf±50 MAX 2. LIFE : 50.000 CYCLES 3. TRAVEL : 0.15±0.1mm

NOTE

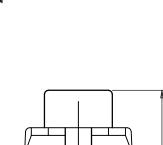


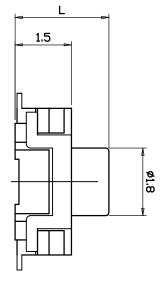


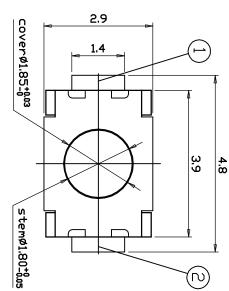
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INNOCENT ELECTRONICS CO.LTD

1. GENERAL MATTERS

- 1.1 Application : This specification is applied to low current tactile switch for electronic equipment.
- 1. 2 Operating Temperature Range : -20°C ~ 70°C, 45 ~ 85% RH
- 1. 3 Test Condition : The standard test conditions shall be 5° C ~ 35° C in temperature,
 - 45 ~ 85% RH and 860 ~ 1060mbar in atmospheric pressure.
 - Should any doubt arise in judgment, tests shall be conducted at 20 $\pm 2^{\circ}$, 65 $\pm 5\%$ RH and 860 ~ 1060mbar.

2. RATED VOLTAGE AND CURRENT

12V DC, 50mA

3. ELECTRICAL PERFORMANCE

	PROPERTY	TEST CONDITION	PERFORMANCE
3. 1	Contact Resistance	Measured at 50mA, 12V DC	100mΩ Max
3. 2	Insulation Resistance	DC 500C is applied between terminals and earth for 1 minute ± 5 seconds.	100mΩ Min
3. 3	Withstand Voltage	250V AC(50~ 60HZ) is applied between terminals and earth for 1 minute.	No insulation defect shall be observed.
3. 4	Bounce	Measured by lightly striking the center of the button stem at a rate of 3 operation/sec.	10msec. Max

4. MECHANICAL PERFORMANCE

	PROPE	RTY	TEST CONDITION			PERFORMA	NCE
4. 1	Operc	iting Force	A gradually increasing load is applied to the center of the button stem.			250± 50gf	
4. 2	Terminal Strength A static force of 500gf shall be applied to an arbitrary.		Shall be free from terminal looseness, damage and brea- kdown of insulator.				
4. 3	Stop Strength		A static force of 3Kgf shall be applied to the direction of operation for 3 seconds.		Shall be free from mechanical and ele- ctrical abnormalities.		
4. 4	Solder Heat Resistance		Soldering temperature : 245 ~ 255°C Soldering time : 10sec.		Shall be free from mechanical and ele- ctrical degradation.		
4.5	Travel					0.15 ± 0.1mm	
4. 6	Arrang	gement of action			Tactile feed-back		
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DATE				DESIGNED	CHECKED	APPROVED	PAGE
S/W TYPE		SMD TACT S/W					1/
MODEL	NO.	INT-1410					'/3
DOCUM	ENT NO.	STS-031		/ /	/ /	/ /	

	PROPERTY	TEST CONDITION	PERFORMANCE	
5.1	Operating Life	Measurements shall be made following the test	Contact Resistance :	
		set forth below :	100mΩ Max	
		1) 5V DC, 5mA resistive load.	Bounce :	
		2) Rate of operation 2 to 3 operations per second.	20m sec Max	
		3) Depression : Twice the actuating force.	Actuating Force :	
		4) Cycles of operation : 50,000 cycles	within $\pm 50\%$ of	
			the initial value	
			Item 3. 3	
			Item 4.5	
5.2	Vibration Resistance	Measurements shall be made following the test	Item 3. 1	
		set forth below :	Item 3. 2	
		*Range of oscillation : 10 to 55Hz	Item 3. 3	
		*Amplitude, pk-to-pk : 1.5mm		
		*Cycle of sweep : 10-55-10Hz in one minute, approx.		
		*Mode of sweep : logarithmical sweep or uniform		
		sweep.		
		*Direction of oscillation :		
		three mutually perpendicular directions,		
		including the direction of stem travel.		
		*Duration of testing :		
		2 hours each, for a total of 6 hours.		
5.3	Impact Shock Resistance	Measurements shall be made following the test	Item 3. 1	
		set forth below :	Item 3. 2	
		*Acceleration : 80g	Item 3. 3	
		*cycle of test : 3 cycles each in 6 direction, for a		
		total of 18 cycles.		

6	ENVIRONMENTAL
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	PROPERTY	TEST CONDITIONS	PERFORMANCE
6.1	Resistance to	Following the test set forth below the sample shall	Item 3.1
	Low Temperature	be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements	Item 3.3
		are made :	
		*temperature : -30 $\pm 2^{\circ}$	
		*time : 96 hours	
		*waterdrops shall be removed.	
6.2	Heat Resistance	Following the test set forth below the sample shall	Item 3. 1
		be left in normal temperature and humidity	Item 3. 2
		conditions for one hour before measurements are made :	Item 3. 3
		*temperature/time : 80 ±2°C/96hr	

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	PROPERTY	TEST CONDITION	PERFORMANCE
6.3	Moisture Resistance	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for one hour before measurements are made : *temperature/time : 80 ±2°C/96hr	Contact Resistance : 100mΩ Max Insulation Resistance 10MΩ Min Item 3. 3, 3. 4 Item 4. 1, 4. 5
6. 4	Temperature Cycling	Following 5 cycles of the temperature cycling test set forth below the sample shall be left in normal temperature and humidity conditions for one hour during this test, waterdrops shall be removed. $\frac{1 \text{ cycle}}{+60 \text{ °C}}$ -10 °C $2H$ $1H$ $2H$ $1H$	Item 3. 1 Item 4. 1 Item 4. 5

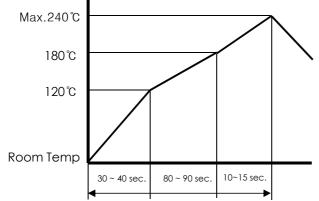
7. REFLOW SOLDERING

7.1 Refer to the following time temperature chart.

It is recommended to determine soldering conditions through verification test and on prior agreement of INNOCENT ELEC., since surface temperature varies depending upon material, size and thickness PCB.

7.2 Other precautions

- 1) Switch shall not be washed after soldering with solvent or the like.
- 2) Soldering shall be controlled so as not to allow flux penetrates switch at its upper face.
- 3) Switch terminals and PCB upper face shall be free from flux prior to soldering.



Above-mentions time-temperature chart is based on the temperature in the part mounting surface of PCB.

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